

PROCESSING METHOD AND CUTTING APPARATUS

ABSTRACT

A processing method includes a half cutting step of causing a first blade to cut into a package substrate and cutting the package substrate by the first blade along a planned dividing line to form a first cut groove and form an uncut residual part under the first cut groove, a full cutting step of cutting the uncut residual part along the first cut groove by a second blade thinner than the first blade after the half cutting step is executed, and a tip shape check step of checking the shape of the tip of the first blade.

[Fig. 7]